

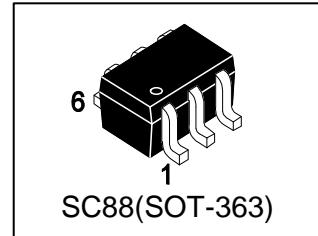
# LBSS8402DW1T1G

## S-LBSS8402DW1T1G

### POWER MOSFET

#### 1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.

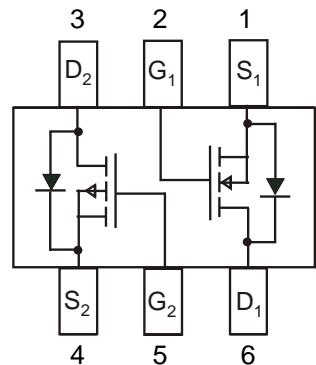


#### 2. DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LBSS8402DW1T1G	402	3000/Tape&Reel
LBSS8402DW1T3G	402	10000/Tape&Reel

#### 3. MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
Drain–Source Voltage	VDSS	50	V
Gate-to-Source Voltage – Continuous	VGS	±20	V
Drain Current			mA
– Continuous (Ta = 25°C)	ID	130	
– Pulsed Drain Current (tp ≤ 10 μs)	IDM	520	
Total Power Dissipation @ TA = 25°C	PD	380	mW
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	328	°C/W
Junction and Storage temperature range	T <sub>J,Tstg</sub>	-55~+150	°C
Maximum Lead Temperature for Soldering Purposes, for 10 seconds	TL	260	°C



#### 4. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

##### N-Channel

##### OFF CHARACTERISTICS

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain–Source Breakdown Voltage (VGS = 0, ID = 250µA)	VBRDSS	50	-	-	V
Zero Gate Voltage Drain Current (VDS = 25 V, VGS = 0 V) (VDS = 50 V, VGS = 0 V)	IDSS	-	-	0.1 0.5	µA
Gate–Source Leakage Current (VGS = ± 20 V, VDS = 0 V)	IGSS	-	-	±0.1	µA

##### ON CHARACTERISTICS (Note 1)

Gate–Source Threshold Voltage (VDS = VGS , ID = 1.0 mA)	VGS(th)	0.5	-	1.5	V
Static Drain–Source On–State Resistance (VGS= 2.75 V, ID < 200 mA, TA = –40°C to +85°C (VGS = 5.0 V, ID = 200 mA)	RDS(on)	- -	5.6 -	10 3.5	Ohm

##### DYNAMIC CHARACTERISTICS

Input Capacitance (VDS = 25 V, VGS = 0, f = 1 MHz)	Ciss	-	42	-	pF
Output Capacitance (VDS = 25 V, VGS = 0, f = 1 MHz)	Coss	-	15	-	pF
Transfer Capacitance (VDS = 25 V, VGS = 0, f = 1 MHz)	Crss	-	3	-	pF

##### SWITCHING CHARACTERISTICS(Note 2)

Turn-On Delay Time	(VDD = 30 V, ID = 0.2A)	td(on)	-	5	-	ns
Turn-Off Delay Time		td(off)	-	7	-	

#### 4 ELECTRICAL CHARACTERISTICS (Ta= 25°C)(Con.)

##### P-Channel

###### OFF CHARACTERISTICS

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain–Source Breakdown Voltage (VGS = 0, ID = -250µA)	VBRDSS	-50	-	-	V
Zero Gate Voltage Drain Current (VDS = -25 V, VGS = 0 V) (VDS = -50 V, VGS = 0 V) (VDS = -50 V, VGS = 0 V, TJ = 125°C)	IDSS	-	-	-0.1	µA
		-	-	-15	
		-	-	-60	
Gate–Source Leakage Current (VGS = ± 20 V, VDS = 0 V)	IGSS	-	-	±0.1	µA

###### ON CHARACTERISTICS (Note 1)

Gate–Source Threshold Voltage (VDS = VGS , ID = -250 µA)	VGS(th)	-0.8	-	-2.0	V
Static Drain–Source On–State Resistance (VGS = -5.0 V, ID = -100 mA)	RDS(on)	-	5	10	Ohm

###### DYNAMIC CHARACTERISTICS

Input Capacitance (VDS = -5 V)	Ciss	-	30	-	pF
Output Capacitance (VDS = -5 V)	Coss	-	10	-	pF
Transfer Capacitance (VDS = -5 V)	Crss	-	5	-	pF

###### SWITCHING CHARACTERISTICS(Note 2)

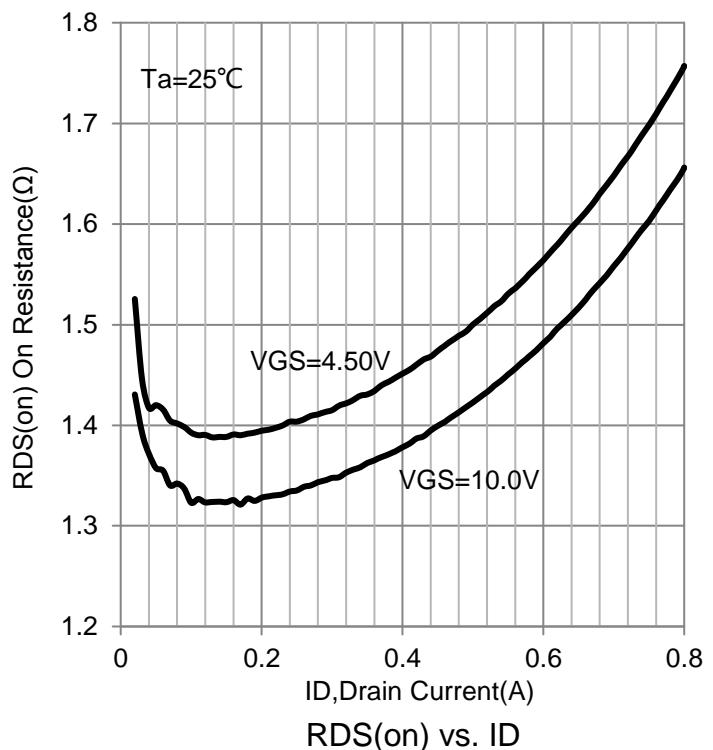
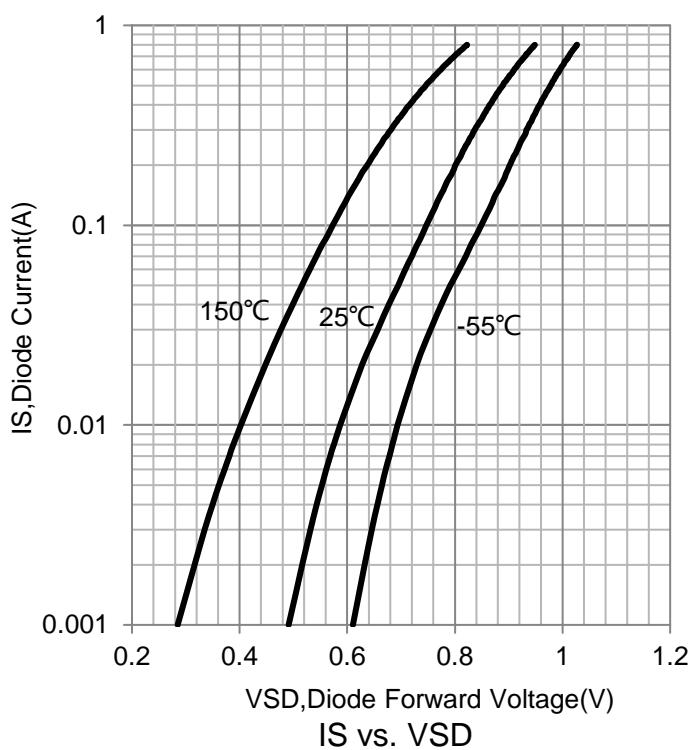
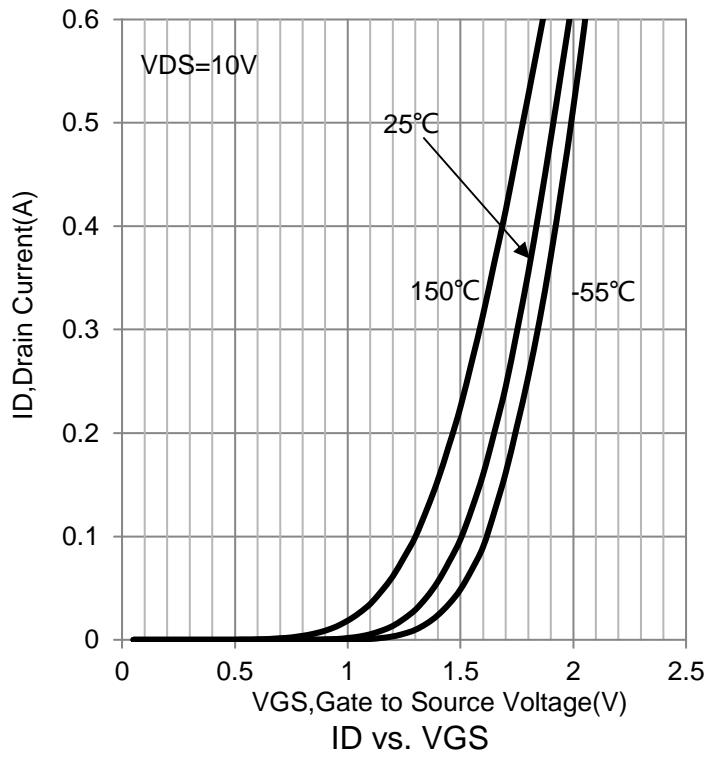
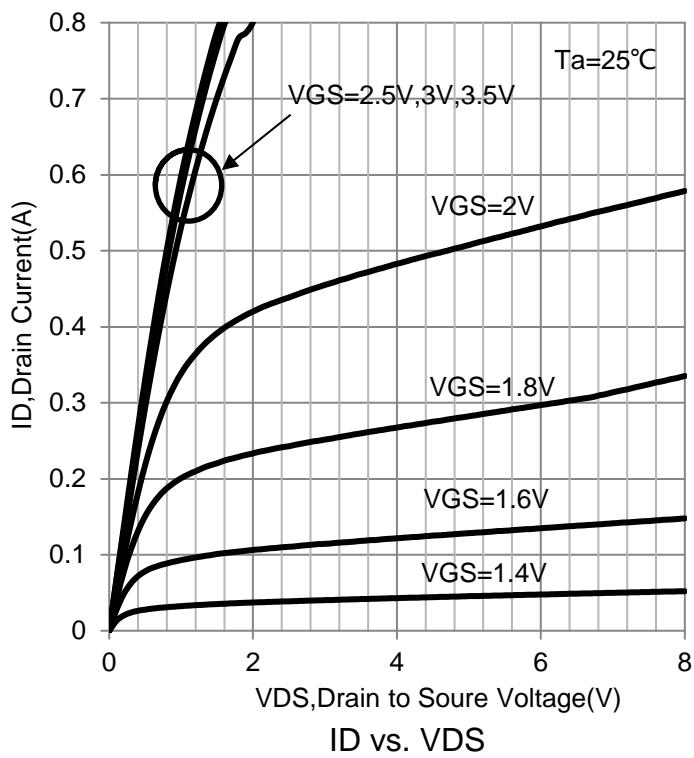
Turn–On Delay Time	(VDS = -15 V,VGS=-10V ,RL = 50Ω,RG=25Ω)	td(on)	-	16.7	-	ns
Rise Time		tr	-	8.6	-	
Turn–Off Delay Time		td(off)	-	17.9	-	
Fall Time		tf	-	5.3	-	
Gate Charge		QT	-	6000	-	

1.Pulse Test: Pulse Width ≤300 µs, Duty Cycle ≤2.0%.

2. Switching characteristics are independent of operating junction temperature.

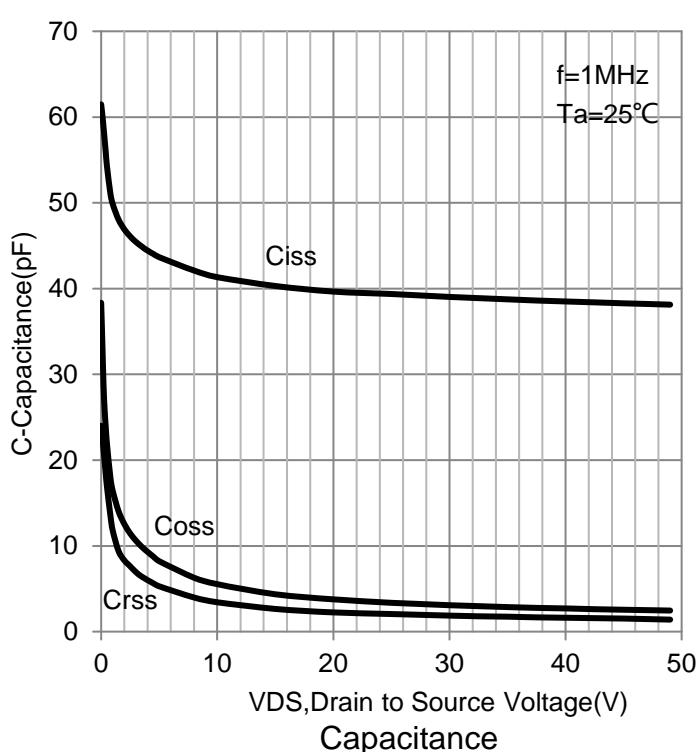
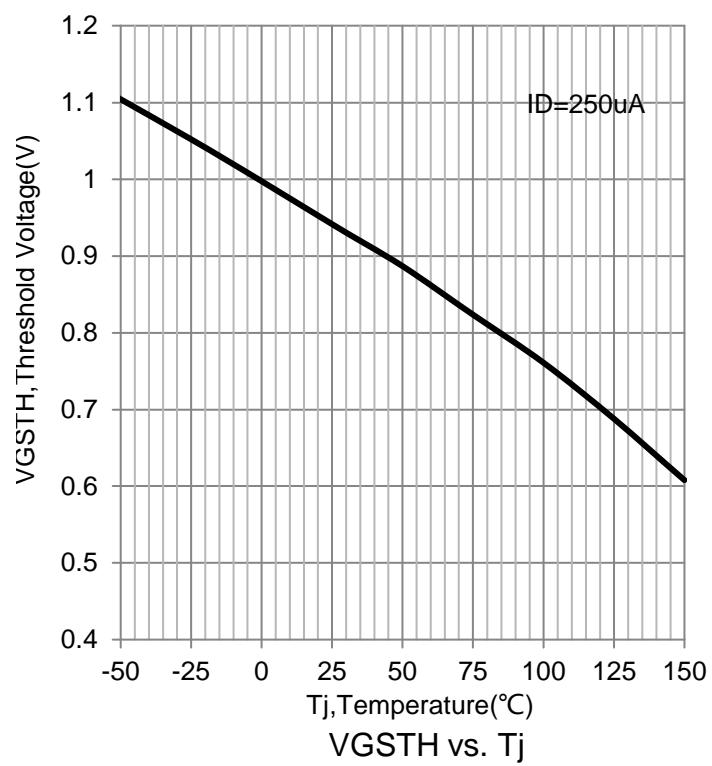
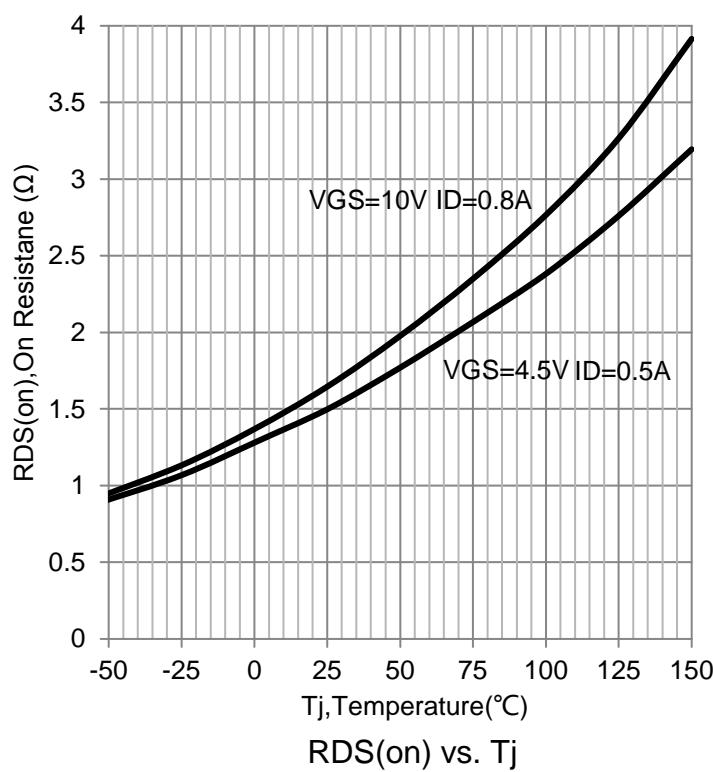
## 5.ELECTRICAL CHARACTERISTICS CURVES

N-Channel



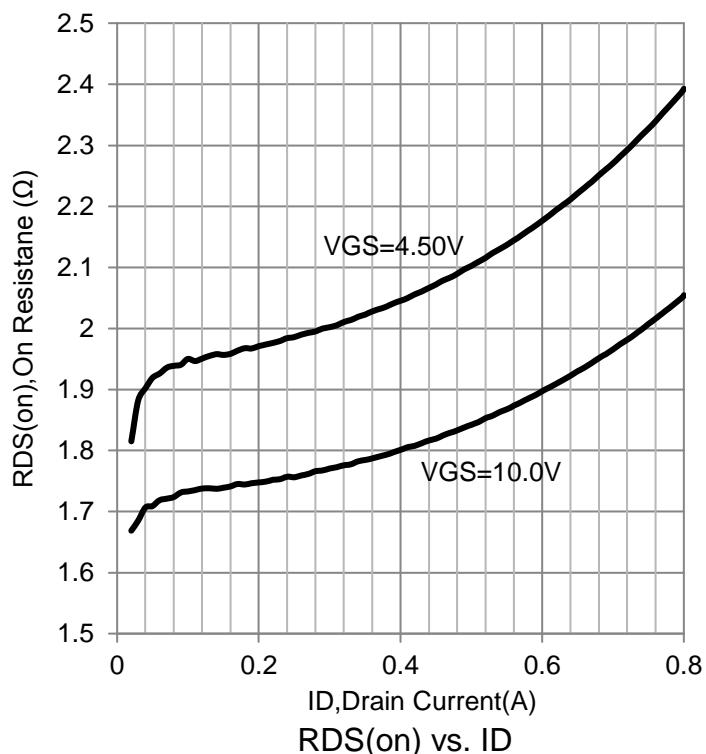
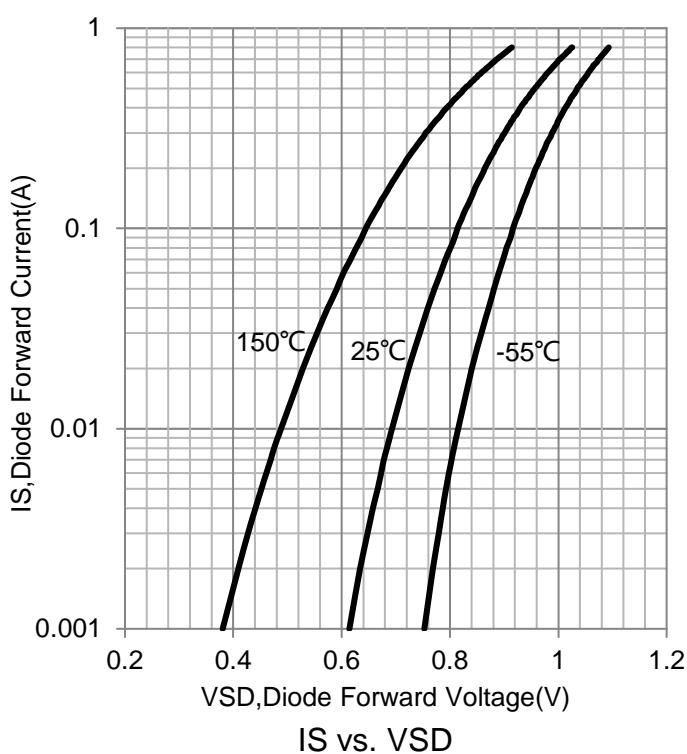
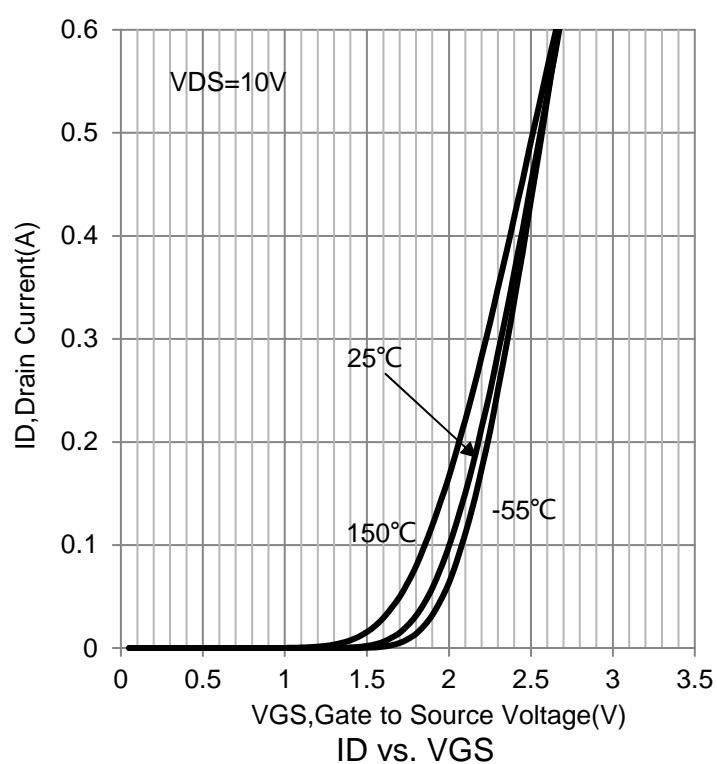
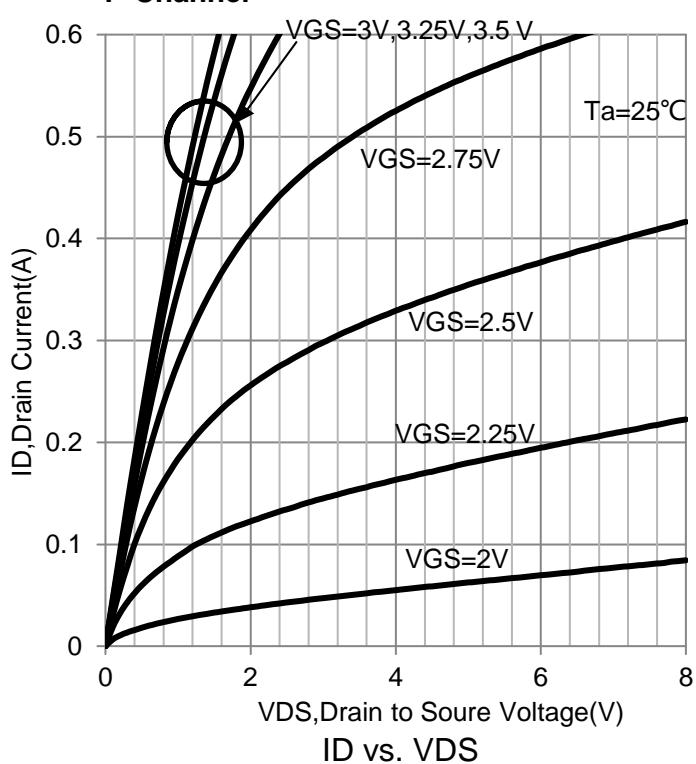
## 5.ELECTRICAL CHARACTERISTICS CURVES (Con.)

N-Channel



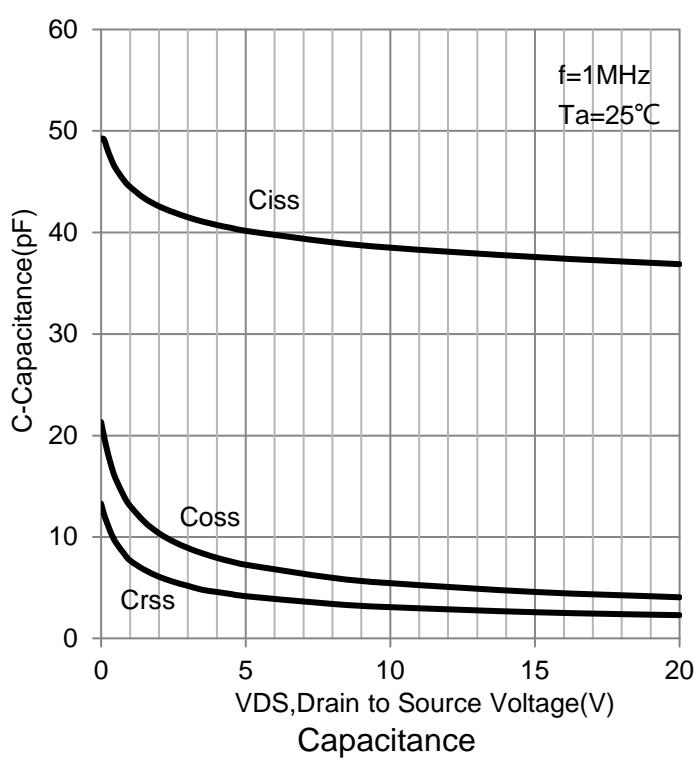
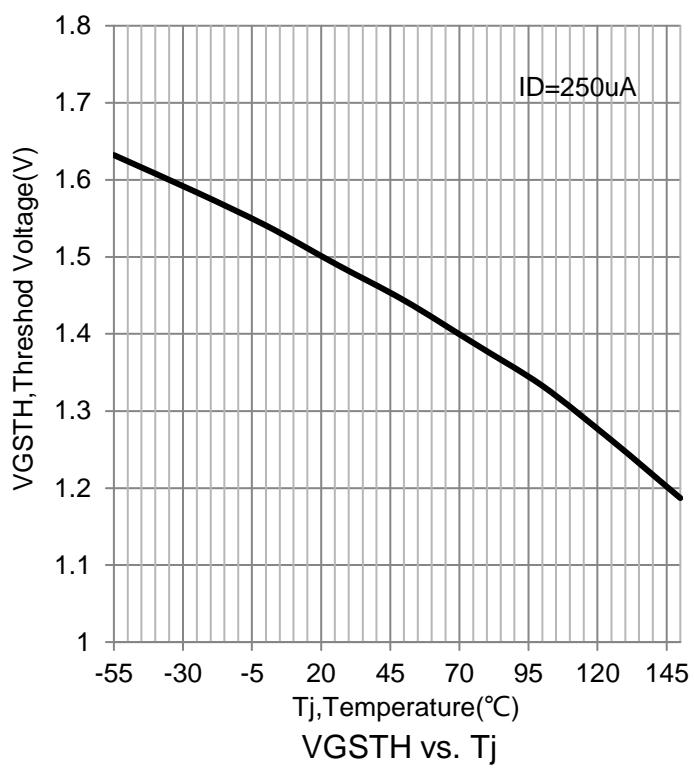
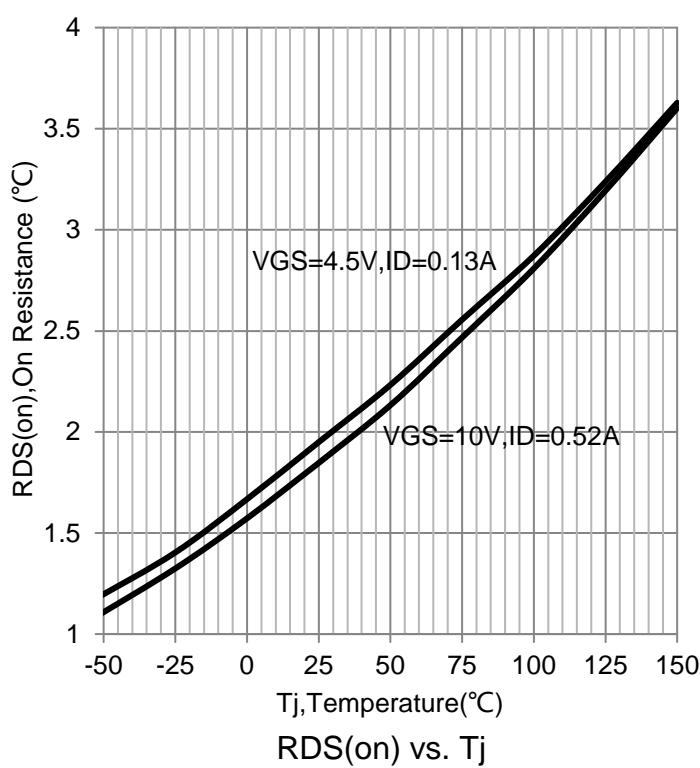
## 5. ELECTRICAL CHARACTERISTICS CURVES (Con.)

P-Channel

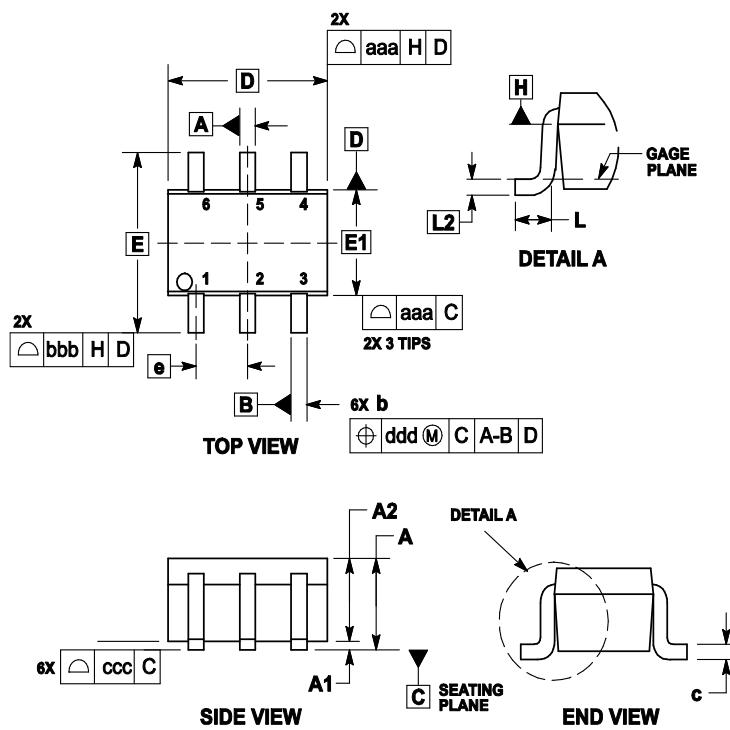


## 5. ELECTRICAL CHARACTERISTICS CURVES (Con.)

P-Channel



## 6. OUTLINE AND DIMENSIONS

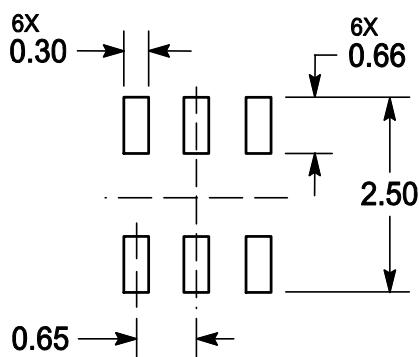


Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	---	---	1.10	---	---	0.043
A1	0.00	---	0.10	0	---	0.004
A2	0.70	0.90	1.00	0.027	0.035	0.039
b	0.15	0.20	0.25	0.006	0.008	0.01
C	0.08	0.15	0.22	0.003	0.006	0.009
D	1.80	2.00	2.20	0.07	0.078	0.086
E	2.00	2.10	2.20	0.078	0.082	0.086
E1	1.15	1.25	1.35	0.045	0.049	0.053
e	0.65 BSC			0.026 BSC		
L	0.26	0.36	0.46	0.010	0.014	0.018
L2	0.15 BSC			0.006 BSC		
aaa	0.15			0.01		
bbb	0.30			0.01		
ccc	0.10			0.00		
ddd	0.10			0.00		

## 7. SOLDERING FOOTPRINT



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